

July 2009

HI-1567, HI-1568

MIL-STD-1553 / 1760 5V Monolithic Dual Transceivers

DESCRIPTION

The HI-1567 and HI-1568 are low power CMOS dual transceivers designed to meet the requirements of MIL-STD-1553/1760 specifications.

The transmitter section of each bus takes complementary CMOS/TTL Manchester II bi-phase data and converts it to differential voltages suitable for driving the bus isolation transformer. Separate transmitter inhibit control signals are provided for each transmitter.

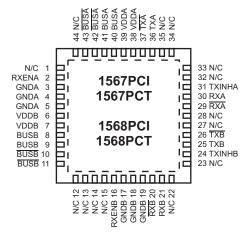
The receiver section of the each bus converts the 1553 bus bi-phase differential data to complementary CMOS / TTL data suitable for inputting to a Manchester decoder. Each receiver has a separate enable input which can be used to force the output of the receiver to a logic 0 (HI-1567) or logic 1 (HI-1568).

To minimize the package size for this function, the transmitter outputs are internally connected to the receiver inputs, so that only two pins are required for connection to each coupling transformer. For designs requiring independent access to transmitter and receiver 1553 signals, please refer to the HI-1569 data sheet.

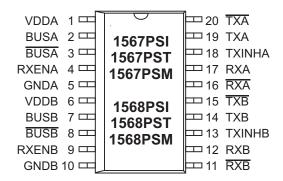
FEATURES

- Compliant to MIL-STD-1553A & B, MIL-STD-1760, ARINC 708A
- CMOS technology for low standby power
- Smallest footprint available in 44-pin plastic chip-scale package with integral heatsink
- Less than 1.0W maximum power dissipation
- Radiation tolerant
- Also available in DIP and small outline (ESOIC) package options
- Industrial and extended temperature ranges
- Industry standard pin configurations

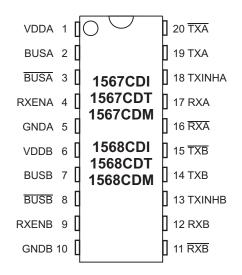
PIN CONFIGURATIONS



44 Pin Plastic 7mm x 7mm Chip-scale package



20 Pin Plastic ESOIC - WB package



20 Pin Ceramic DIP package

PIN DESCRIPTIONS

PIN (DIP/ESOIC)	SYMBOL	FUNCTION	DESCRIPTION	
1	VDDA	power supply	+5 volt power for bus A	
2	BUSA	analog output	MIL-STD-1533 bus driver A, positive signal	
3	BUSA	analog output	MIL-STD-1553 bus driver A, negative signal	
4	RXENA	digital input	Receiver A enable. If low, forces RXA and RXA low (HI-1567) or High (HI-1568)	
5	GNDA	power supply	Ground for bus A	
6	VDDB	power supply	+5 volt power for bus B	
7	BUSB	analog output	MIL-STD-1533 bus driver B, positive signal	
8	BUSB	analog output	MIL-STD-1553 bus driver B, negative signal	
9	RXENB	digital input	Receiver B enable. If low, forces RXB and RXB low (HI-1567) or High (HI-1568)	
10	GNDB	power supply	Ground for bus B	
11	RXB	digital output	Receiver B output, inverted	
12	RXB	digital output	Receiver B output, non-inverted	
13	TXINHB	digital input	Transmit inhibit, bus B. If high BUSB, BUSB disabled	
14	TXB	digital input	Transmitter B digital data input, non-inverted	
15	TXB	digital input	Transmitter B digital data input, inverted	
16	RXA	digital output	Receiver A output, inverted	
17	RXA	digital output	Receiver A output, non-inverted	
18	TXINHA	digital input	Transmit inhibit, bus A. If high BUSA, BUSA disabled	
19	TXA	digital input	Transmitter A digital data input, non-inverted	
20	TXA	digital input	Transmitter A digital data input, inverted	

FUNCTIONAL DESCRIPTION

The HI-1567 family of data bus transceivers contain differential voltage source drivers and differential receivers. They are intended for applications using a MIL-STD-1553 A/B data bus. The device produces a trapezoidal output waveform during transmission.

TRANSMITTER

Data input to the device's transmitter section is from the complementary CMOS /TTL inputs TXA/B and TXA/B. The transmitter accepts Manchester II bi-phase data and converts it to differential voltages on BUSA/B and BUSA/B. The transceiver outputs are either direct or transformer coupled to the MIL-STD-1553 data bus. Both coupling methods produce a nominal voltage on the bus of 7.5 volts peak to peak.

The transmitter is automatically inhibited and placed in the high impedance state when both TXA/B and TXA/B are either at a logic "1" or logic "0" simultaneously. A logic "1" applied to the TXINHA/B input will force the transmitter to the high impedance state, regardless of the state of TXA/B and TXA/B.

RECEIVER

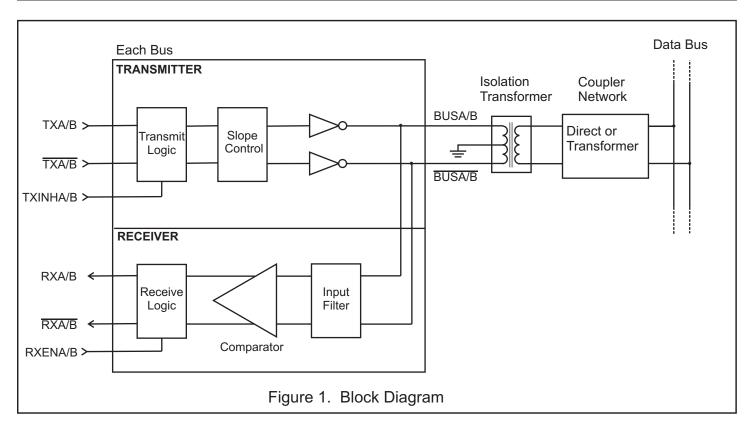
The receiver accepts bi-phase differential data from the MIL-STD-1553 bus through the same direct or transformer coupled interface as the transmitter. The receiver's differential input stage drives a filter and threshold comparator that produces CMOS/TTL data at the RXA/B and RXA/B output pins.

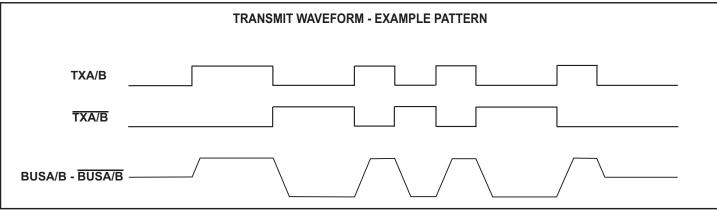
Each set of receiver outputs can be independently forced to a logic "0" (HI-1567) or logic "1" (HI-1568) by setting RXENA or RXENB low.

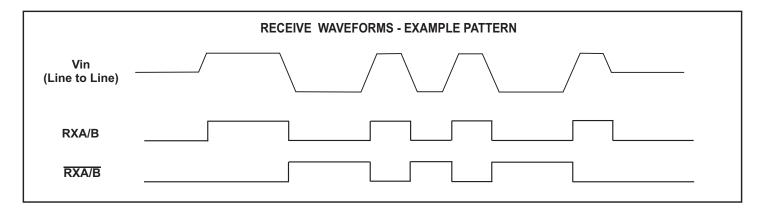
MIL-STD-1553 BUS INTERFACE

A direct coupled interface (see Figure 2) uses a 1:2.5 ratio isolation transformer and two 55 ohm isolation resistors between the transformer and the bus.

In a transformer coupled interface (see Figure 3), the transceiver is connected to a 1:1.79 isolation transformer which in turn is connected to a 1:1.4 coupling transformer. The transformer coupled method also requires two coupling resistors equal to 75% of the bus characteristic impedence (Zo) between the coupling transformer and the bus.







ABSOLUTE MAXIMUM RATINGS

Supply voltage (VDD)	-0.3 V to +7 V		
Logic input voltage range	-0.3 V dc to +5.5 V		
Receiver differential voltage	10 Vp-p		
Driver peak output current	+1.0 A		
Power dissipation at 25°C ceramic DIL, derate	1.0 W 7mW/°C		
Solder Temperature	275°C for 10 sec.		
Junction Temperature	175°C		
Storage Temperature	-65°C to +150°C		

RECOMMENDED OPERATING CONDITIONS

Supply Voltage
VDD 5V ±5%
Temperature Range
Industrial Screening40°C to +85°C Hi-Temp Screening55°C to +125°C

NOTE: Stresses above absolute maximum ratings or outside recommended operating conditions may cause permanent damage to the device. These are stress ratings only. Operation at the limits is not recommended.

DC ELECTRICAL CHARACTERISTICS

VDD = 5.0V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		4.75	5	5.25	V
Total Supply Current	ICC1	Not Transmitting		14	22	mA
	ICC2	Transmit one bus @ 50% duty cycle		200	340	mA
	ICC3	Transmit one bus @ 100% duty cycle		400	550	mA
Power Dissipation	PD1	Not Transmitting			0.11	W
	PD2	Transmit one bus @ 100% duty cycle		0.70	0.95	W
Min. Input Voltage (HI)	Vih	Digital inputs	2.0	1.4		V
Max. Input Voltage (LO)	VIL	Digital inputs		1.4	0.8	V
Min. Input Current (HI)	Іін	Vıн = 4.9V, Digital inputs			20	μA
Max. Input Current (LO)	lıL	VIL = 0.1V, Digital inputs	-20			μA
Min. Output Voltage (HI)	Voн	louτ = -0.4mA, Digital outputs	2.7			V
Max. Output Voltage (LO)	Vih	Iουτ = 4.0mA, Digital outputs			0.4	V
RECEIVER (Measured at Point "Ap" in	Figure 2 unles	s otherwise specified)				
Input resistance	Rin	Differential	20			Kohm
Input capacitance	CIN	Differential			5	pF
Common mode rejection ratio	CMRR		40			dB
Input Level	Vin	Differential			9	Vp-p
Input common mode voltage	Vicм		-5.0		5.0	V-pk
Threshold Voltage - Direct-coupled Detect	VTHD	1 Mhz Sine Wave	1.15		20.0	Vp-p
No Detect	VTHND	(Measured at Point "Aɒ" in Figure 2)			0.28	Vp-p
Threshold Voltage - Transformer-coupled Detect	VTHD	1 MHz Sine Wave	0.86		14.0	Vp-p
No Detect	VTHND	(Measured at Point "Aτ" in Figure 3)			0.20	Vp-p

DC ELECTRICAL CHARACTERISTICS (cont.)

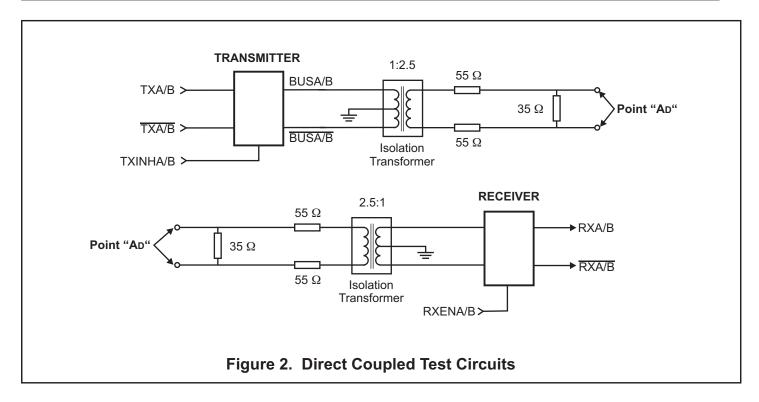
VDD = 5.0V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

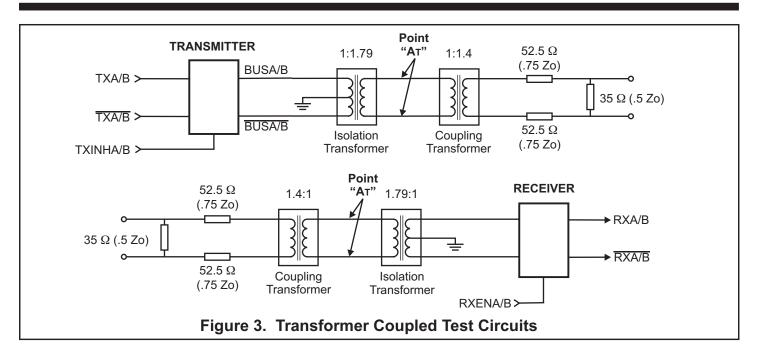
	PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
TRANSMITTER	(Measured at Point "AD" in Fi	gure 2 unless	otherwise specified)				
Output Voltage	Direct coupled	Vouт	35 ohm load (Measured at Point "Ap" in Figure 2)	7.0		9.0	Vp-p
	Transformer coupled	Vouт	70 ohm load (Measured at Point "Ατ" in Figure 3)	20.0		27.0	Vp-p
Output Noise		Von	Differential, inhibited			10.0	mVp-p
Output Dynamic (Offset Voltage Direct coupled	Vdyn	35 ohm load (Measured at Point "Ap" in Figure 2)	-90		90	mV
	Transformer coupled	Vdyn	70 ohm load (Measured at Point "Aτ" in Figure 3)	-250		250	mV
Output resistance	•	Rout	Differential, not transmitting	10			Kohm
Output Capacitan	ce	Соит	1 MHz sine wave			15	pF

AC ELECTRICAL CHARACTERISTICS

VDD = 5.0V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
RECEIVER (Measured at Point "AD" in Figure 2)						
Receiver Delay	tDR	From input zero crossing to RXA/B or RXA/B			450	ns
Receiver Enable Delay	tREN	From RXENA/B rising or falling edge to			40	ns
	uxerv	RXA/B or RXA/B			40	113
TRANSMITTER (Measured a	TRANSMITTER (Measured at Point "AD" in Figure 2)					
Driver Delay	tDT	TXA/B, TXA/B to BUSA/B, BUSA/B			150	ns
Rise time	tr	35 ohm load	100		300	ns
Fall Time	tf	35 ohm load	100		300	ns
Inhibit Delay	tDI-H	Inhibited output			100	ns
	tDI-L	Active output			150	ns





HEAT SINK - ESOIC & CHIP-SCALE PACKAGE

Both the HI-1567PSI/T/M and HI-1568PSI/T/M use a 20-pin thermally enhanced SOIC package. The HI-1567PCI/T and HI-1568PCI/T use a plastic chip-scale package. These packages include a metal heat sink located on the bottom surface of the device. This heat

sink should be soldered down to the printed circuit board for optimum thermal dissipation. The heat sink is electrically isolated and may be soldered to any convenient power or ground plane..

THERMAL CHARACTERISTICS

PART NUMBER	PACKAGE STYLE	CONDITION	Ø	JUNCTION TEMPERATURE			
PART NUMBER	PACKAGE STILE	CONDITION	Ø _{JA}	T _A =25°C	T _A =85°C	T _A =125°C	
HI-1567PSI / T / M	20-pin Thermally	Heat sink unsoldered	54°C/W	62°C	122°C	162°C	
HI-1568PSI / T / M	enhanced plastic SOIC (ESOIC)	Heat sink soldered	47°C/W	57°C	117°C	157°C	
HI-1567CDI / T / M HI-1568CDI / T / M	20-pin Ceramic side-brazed DIP	Socketed	62°C/W	69°C	129°C	169°C	
HI-1567PCI / T HI-1568PCI / T	44-pin Plastic chip- scale package	Heat sink unsoldered	49°C/W	59°C	119°C	159°C	

Data taken at VDD=5.0V, continuous transmission at 1Mbit/s, single transmitter enabled.

RADIATION TOLERANCE

The HI-1567 has been characterized for total dose radiation performance in accordance with MIL-STD-883 method 1019. The part meets all data sheet parameters after exposure to 25 KRad(Si).

APPLICATIONS NOTE

Holt Applications Note AN-500 provides circuit design notes regarding the use of Holt's family of MIL-STD-1553 transceivers. Layout considerations, as well as recommended interface and protection components are included.

ORDERING INFORMATION

HI - <u>156x xx x x</u> (Plastic)

PART NUMBER	LEAD FINISH
Blank	Tin / Lead (Sn / Pb) Solder
F	100% Matte Tin (Pb-free, RoHS compliant)

PART NUMBER	TEMPERATURE RANGE	FLOW	BURN IN
I	-40°C TO +85°C	I	NO
Т	-55°C TO +125°C	Т	NO
М	-55°C TO +125°C	М	YES

PART NUMBER	PACKAGE DESCRIPTION
PC	44 PIN PLASTIC CHIP-SCALE LPCC (44PCS) not available with 'M' flow
PS	20 PIN PLASTIC ESOIC (Thermally Enhanced Wide SOIC w/Heat Sink, 20HWE)

PART	RXEN	A = 0	RXENB = 0		
NUMBER	RXA	RXA	RXB	RXB	
1567	0	0	0	0	
1568	1	1	1	1	

HI - 156xCD x (Ceramic)

PART NUMBER	TEMPERATURE RANGE	FLOW	BURN IN	LEAD FINISH
I	-40°C TO +85°C	I	NO	Gold (Pb-free, RoHS compliant)
Т	-55°C TO +125°C	Т	NO	Gold (Pb-free, RoHS compliant)
М	-55°C TO +125°C	М	YES	Tin / Lead (Sn / Pb) Solder

	PART	RXENA = 0		RXENB = 0		PACKAGE	
l	NUMBER	RXA	RXA	RXB	RXB	DESCRIPTION	
	1567CD	0	0	0	0	20 PIN CERAMIC SIDE BRAZED DIP (20C)	
	1568CD	1	1	1	1	20 PIN CERAMIC SIDE BRAZED DIP (20C)	

RECOMMENDED TRANSFORMERS

The HI-1567 and HI-1568 transceivers have been characterized for compliance with the electrical requirements of MIL-STD-1553 when used with the following

transformers. Holt recommends the Premier Magnetics parts as offering the best combination of electrical performance, low cost and small footprint.

MANUFACTURER	PART NUMBER	APPLICATION	TURNS RATIO(S)	DIMENSIONS
Technotrol	TL1553-45	Isolation	Dual tapped 1:1.79, 1:2.5	.630 x 630 x .155 inches
Premier Magnetics	PM-DB2725EX	Isolation	Dual tapped 1:1.79, 1:2.5	.500 x .500 x .375 inches
Technotrol	TQ1553-2	Stub coupling	1:1.4	.625 x .625 x .250 inches
Premier Magnetics	PM-DB2702	Stub coupling	1:1.4	.625 x .625 x .250 inches

REVISION HISTORY

Document	Rev.	Date	Description of Change
DS1567	0	09/26/08	Clarification of transmitter and receiver functions in Description, clarified available temperature ranges, and corrected a dimension in Recommended Transformers table.
	Р	07/24/09	Corrected typographical errors in package dimensions.

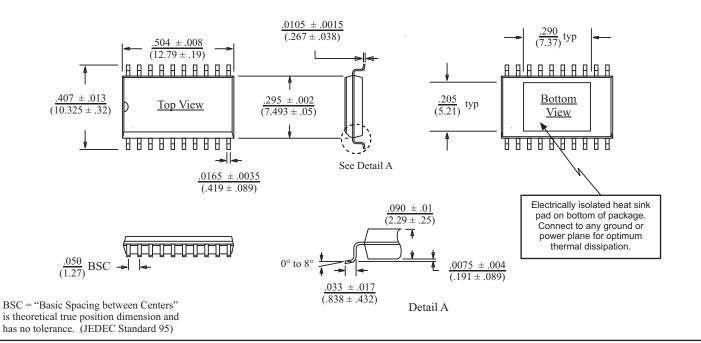
PACKAGE DIMENSIONS

20-PIN PLASTIC SMALL OUTLINE (ESOIC) - WB

(Wide Body, Thermally Enhanced)

inches (millimeters)

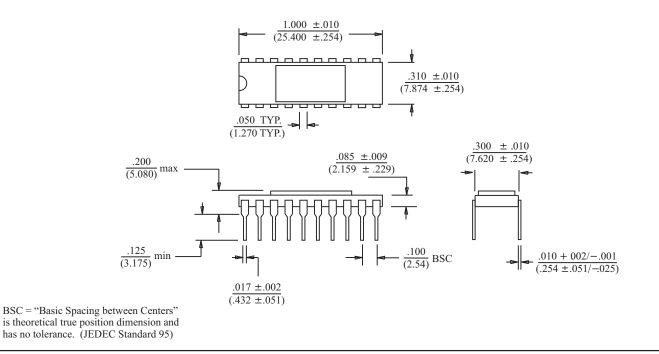
Package Type: 20HWE



20-PIN CERAMIC SIDE-BRAZED DIP

inches (millimeters)

Package Type: 20C





PACKAGE DIMENSIONS

